U.S. PTO

05-11-2007

	11/790826
 *	04/27/2007

01 FC:8021

40.00 DA

	1034	05202 Atty. Docket: BHT-3281
	To the Commissioner of Patents and Trademarks: Please	record the attached original documents or copy thereof.
1.	Name of conveying party(ies):	2. Name and address of receiving party(ies):
	Hung-Hsin HSU Chih-Wei WU	Name: POWERTECH TECHNOLOGY INC.
	Additional name(s) of conveying party(ies) attached?	Foreign Address: No. 26, Datong Rd., Hsinchu Industrial
	Yes X No	Park, Hukou Shiang, Hsinchu, Taiwan, R.O.
3.	Nature of conveyance: X Assignment Merger	Domestic Address:
	Security Agreement Change of Name	
	Other	City: State ZIP
	Execution Date: April 16, 2007	
		Additional name(s) & address(es) attached? Yes X 1
4.	Application number(s) or patent number(s): If this document is being filed together with a new application,	the execution date of the application is: April 16, 2007
	A. Patent Application No.(s)	B. Patent Registration No.(s)
	Additional numbers attached?	Yes X No
5.	Name and address of party to whom correspondence concerning document should be mailed:	6. Number of applications and patents involved: One (1)
	Name: TROXELL LAW OFFICE PLLC	
	5205 Leesburg Pike	7. Total fee (37 CFR 3.41): \$40.00
	Suite 1404	☐ Enclosed
	Falls Church, Virginia 22041-3401	X Authorized to be charged to deposit account
	Telephone No.: (703) 575-2711	8. Deposit account number 501874
		(Attach duplicate copy of this page if paying by deposit account
	Facsimile No.: (703) 575-2707	
	DO NOT USE	THIS SPACE
9.	Statement and signature.	
	To the best of my knowledge and belief, the foregoing information original document.	on is true and correct and any attached copy is a true copy of the
	original aocument.	
	R 7/	Che del
	Bruce H. Troxell Name of Person Signing Signi	April 27, 2007 Date
	Registration No.26,592	
/10/2	007 DBYRNE 00000176 501874 11790826 Total number of	pages including cover sheet, attachments, and documents: 3

PATENT REEL: 019299 FRAME: 0764

ASSIGNMENT

WHEREAS, I (we), HSU, HUNG-HSIN, WU, CHIH-WEI

whose post office address(es) appear below, hereinafter referred to as ASSIGNOR, is (are) the owner(s) of certain new and useful improvements in SUBSTRATE FOR MULTI-CHIP STACKING, MULTI-CHIP STACK PACKAGE UTILIZING THE SUBSTRATE AND ITS APPLICATIONS (Hereinafter referred to as the INVENTION) for which an application for United States Letters Patent was

| executed on even date herewith
| executed on:
| filed on: | Serial No.:
| established by PCT International Patent Application No.:

WHEREAS, POWERTECH TECHNOLOGY INC.

whose post office address is No.26, Datong Rd., Hsinchu Industrial Park, Hukou Shiang, Hsinchu, Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring the entire right, title and interest in and to the same in the United States and throughout the world;

NOW, THERBPORE, for good and valuable consideration, receipt of which is hereby acknowledged, I (we), ASSIGNOR, by these presents do sell, assign and transfer unto said ASSIGNEE, the entire right, title, and interest in and to said INVENTION and application throughout the United States of America, including any and all United States Letters Patent granted on any division, continuation, continuation—in-part and reissue of said application; and the entire right, title and interest in and to the said INVENTION throughout the world, including the right to apply for patents and inventor certificates in respect thereof and to claim priority pursuant to rights accorded ASSIGNOR under the terms of the Parls International Convention and all other available international conventions and treaties; and the entire right, title and interest in and to any and all patents, patents of addition, utility models, patents of importation, revalidation patents and inventor certificates which may be granted throughout the world in respect of said INVENTION.

ALSO, ASSIGNOR hereby agrees to executed any documents that legally may be required in connection with the filing, prosecution and maintenance of said application or any other patent application(s) or inventor certificate(s) in the United States and in foreign countries for said INVENTION, including additional documents that may be required to affirm the rights of ASSIGNEE is and to said INVENTION, all without further consideration. ASSIGNOE also agrees, without further consideration and at ASSIGNEE's expense, to identify and communicate to ASSIGNEE at ASSIGNEE's request documents and information concerning the INVENTION that are within ASSIGNOR's possession or control, and to provide further assurances and testimony on behalf of ASSIGNEE that lawfully may be required of ASSIGNOR in respect of the prosecution, maintenance and defense of any patent application or patent encompassed within the terms of this instrument. ASSIGNOR's obligations under this instrument shall extend to ASSIGNOR's heirs, executors, administrators and other legal representatives.

ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all United States Letters Patent referred to above to ASSIGNEE, as the ASSIGNEE of the entire right, title and interest in and to the same, for ASSIGNEE's sole use and behoof; and for the use and behoof of ASSIGNEE's legal representatives and successors, to the full end of the term for which such Letters Patent may be granted, as fully and entirely as the same would have been held by ASSIGNOR had this assignment and sale not been made.

ASSIGNOR authorizes TROXELL LAW OFFICE PLLC to insert or complete any information in this document needed to effect its recordal in the U.S. Patent and Trademark Office.

Assignor Name HSU, HUNG-HSIN Where Signed	Ade	Press No.26. Datong Rd., Hainchu Industrial Park, Hukou Shiang, Hsinchu, Taiwan, R.O.C.
Date Apr. 16' vov	Sig	nature Michael Hun
	53.	(Notarization preferred but not required)
Before me personally appeared said day of		And acknowledged this instrument to be his (her)
·		
		tary Public

Continued on Next page

PATENT REEL: 019299 FRAME: 0765

JOINT ASSIGNMENT - NOTARIZATION

ASSIGNMENT

Assignor Name WU, CHIH-WEI	Address No.26	Datong Rd., Hainchu Industrial Park, Hui		
Where Signed	Stuming	Shiang, Hsinchu, Taiwan, R.O.C.		
Dave Apr. 16, 2007	Signature Kevin Wa			
	3.7.2.2.7	2012 1062		
	55.	(Notarization preferred but not required)		
Before me personally appeared said	day of	And acknowledged this		
м	Notary Public y Commission Expires:			
Assignor Name	Address			
Where Signed				
Date	Signature			
		(Name of the second of the sec		
	\$\$.	(Notarization preferred but not required)		
Before me personally appeared said instrument to be his (her) free act and deed this	day of	And acknowledged thi		
	Marana Bakila			
М	Notary Public y Commission Expires:			
Assignor Name	Address			
Where Signed				
Date	Signature			
		(Notarization preferred but not required)		
N. (1)		•		
Refore me personally appeared saidinstrument to be his (her) free act and deed this	day of	And acknowledged thin, 2007.		
_	Notary Public			
м	y Commission Expires:			

Continued on Next page

PATENT REEL: 019299 FRAME: 0766

RECORDED: 04/27/2007